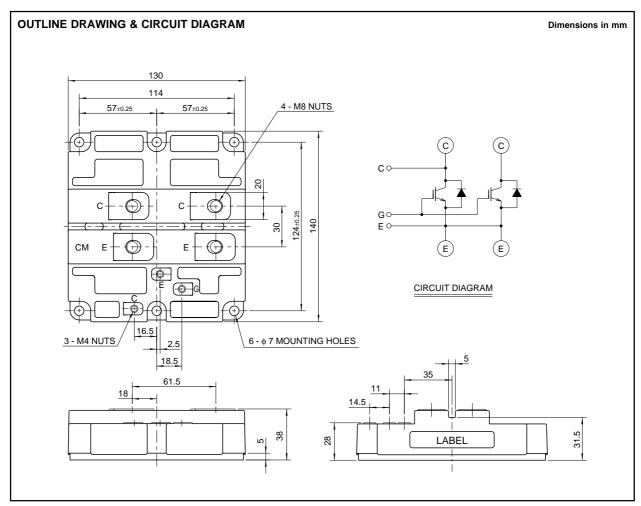
HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE
INSULATED TYPE

APPLICATION

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.



HVIGBT MODULES (High Voltage Insulated Gate Bipolar Transistor Modules)



HIGH POWER SWITCHING USE INSULATED TYPE

HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS (Tj = 25°C)

| Symbol | Item | Conditions | Ratings | Unit |
|--------------|-------------------------------|---|--------------|------|
| VCES | Collector-emitter voltage | VGE = 0V | 1700 | V |
| VGES | Gate-emitter voltage | VCE = 0V | ±20 | V |
| Ic | Collector ourrent | DC, Tc = 95°C | 800 | Α |
| Ісм | Collector current | Pulse (Note | 1600 | Α |
| IE (Note 2) | Emitter current | | 800 | Α |
| IEM (Note 2) | Emilier current | Pulse (Note | 1600 | Α |
| PC (Note 3) | Maximum collector dissipation | Tc = 25°C, IGBT part | 9200 | W |
| Tj | Junction temperature | _ | -40 ~ +150 | °C |
| Tstg | Storage temperature | _ | -40 ~ +125 | °C |
| Viso | Isolation voltage | Charged part to base plate, rms, sinusoidal, AC 60Hz 1min | n. 4000 | V |
| _ | Mounting torque | Main terminals screw M8 | 6.67 ~ 13.00 | N⋅m |
| | | Mounting screw M6 | 2.84 ~ 6.00 | N⋅m |
| | | Auxiliary terminals screw M4 | 0.88 ~ 2.00 | N⋅m |
| _ | Mass | Typical value | 1.5 | kg |

ELECTRICAL CHARACTERISTICS (Tj = 25°C)

| Cumahad | lto-m | Conditions | | Limits | | | l lmit | |
|--------------|--------------------------------|--|-------------------------------|----------|------|--------|--------|-----|
| Symbol | Item | | | Min | Тур | Max | Unit | |
| ICES | Collector cutoff current | VCE = VCES, VGE = 0V | | | _ | _ | 20 | mA |
| VGE(th) | Gate-emitter threshold voltage | IC = 80mA, VCE = 10V | | | 4.5 | 5.5 | 6.5 | V |
| IGES | Gate-leakage current | VGE = VGES, VCE = 0V | | | _ | _ | 0.5 | μΑ |
| VCE(sat) | Collector-emitter | Tj = 25°C | IC = 800A, VGE = 15V (Note 4) | lata (1) | _ | 2.75 | 3.58 | V |
| | saturation voltage | Tj = 125°C | | lote 4) | _ | 3.30 | _ | |
| Cies | Input capacitance | VCE = 10V | | | _ | 93 | _ | nF |
| Coes | Output capacitance | | | _ | 13.3 | _ | nF | |
| Cres | Reverse transfer capacitance | VGE = 0V | | | _ | 5.1 | | nF |
| QG | Total gate charge | VCC = 850V, IC = 800A, VGE = 15V | | | _ | 4.4 | _ | μC |
| td (on) | Turn-on delay time | Vcc = 850V, Ic = 800A | | | _ | _ | 1.20 | μs |
| tr | Turn-on rise time | VGE1 = VGE2 = 15V | | | _ | _ | 1.50 | μs |
| td (off) | Turn-off delay time | $RG = 2.5\Omega$ | | | _ | _ | 2.00 | μs |
| tf | Turn-off fall time | Resistive load switching operation | | | _ | _ | 0.60 | μs |
| VEC (Note 2) | Emitter-collector voltage | IE = 800A, VGE = 0V | | | _ | 2.40 | 3.12 | V |
| trr (Note 2) | Reverse recovery time | IE = 800A | | | _ | _ | 2.00 | μs |
| Qrr (Note 2) | Reverse recovery charge | die / dt = -1600A / μs | | | _ | 135 | _ | μC |
| Rth(j-c)Q | Th | Junction to case, IGBT part | | _ | _ | 0.0135 | K/W | |
| Rth(j-c)R | Thermal resistance | Junction to case, FWDi part | | | | _ | 0.042 | K/W |
| Rth(c-f) | Contact thermal resistance | Case to fin, conductive grease applied | | | | 0.012 | _ | K/W |

- Note 1. Pulse width and repetition rate should be such that the device junction temp. (Tj) does not exceed T_{jmax} rating.

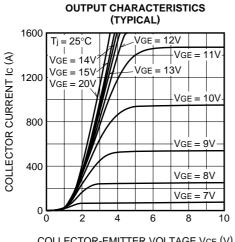
 2. IE, VEC, trr, Qrr & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.
 - 3. Junction temperature (Tj) should not increase beyond 150°C.
 - 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.



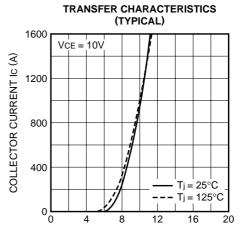
HIGH POWER SWITCHING USE INSULATED TYPE

PERFORMANCE CURVES

COLLECTOR-EMITTER SATURATION VOLTAGE VCE(sat) (V)

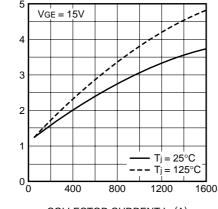


COLLECTOR-EMITTER VOLTAGE VCE (V)



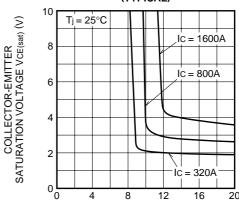
GATE-EMITTER VOLTAGE VGE (V)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



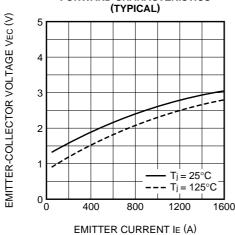
COLLECTOR CURRENT IC (A)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)

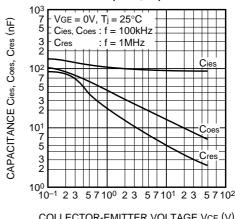


GATE-EMITTER VOLTAGE VGE (V)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS



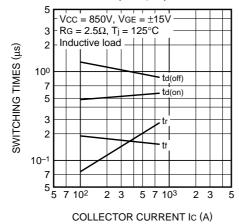
CAPACITANCE CHARACTERISTICS (TYPICAL)



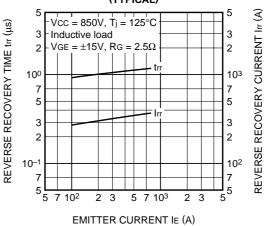
COLLECTOR-EMITTER VOLTAGE VCE (V)

HIGH POWER SWITCHING USE INSULATED TYPE

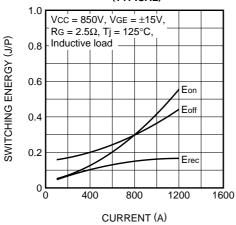
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



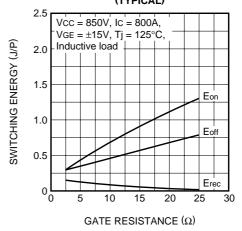
REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



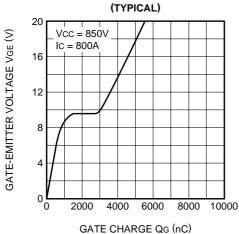
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



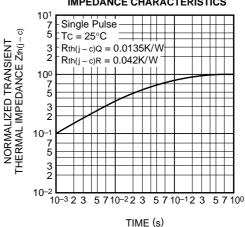
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



GATE CHARGE CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



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